

# PRM5R2N06S8

# PFC Device Corporation

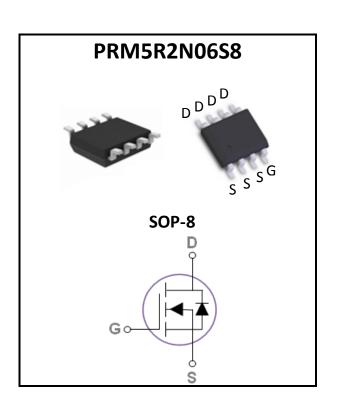
# **60V Single N-Channel MOSFET**

### Major ratings and characteristics

Characteristics	Values	Units
$V_{DS}$	60	٧
I <sub>D</sub> (T <sub>A</sub> =25°C)	18	Α
Max. R <sub>DS(ON)</sub>	5.2	mΩ
T <sub>J</sub> Operating Junction Temperature	-55 to +150	°င

### **General Description**

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.



## **Typical Applications**

- Charger Adapter
- Power Tools
- LED Lighting

#### **Features**

- Max. R<sub>DS(ON)</sub>=5.2mΩ@V<sub>GS</sub>=10V
- Improved dv/dt capability
- Fast switching
- 100% E<sub>AS</sub> Guaranteed
- Green Device Available

# 1. Characteristics

### **Maximum Ratings Characteristics**

( $T_A = 25$  °C unless otherwise specified)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	60	V
$V_{GS}$	Gate-Source Voltage	±20	V
,	Drain Current – Continuous (T <sub>A</sub> =25°C)	18	Α
I <sub>D</sub>	Drain Current – Continuous (T <sub>A</sub> =100°C)	11	Α
I <sub>DM</sub>	Drain Current – Pulsed <sup>1</sup>	72	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>2</sup>	80	mJ
I <sub>AS</sub>	Single Pulse Avalanche Current <sup>2</sup>	40	Α
В	Power Dissipation (T <sub>A</sub> =25°C)	2.5	W
P <sub>D</sub>	Power Dissipation – Derate above 25°C	0.02	W/°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		50	°C/W



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#### **Electrical Characteristics**

( $T_J = 25$  °C unless otherwise specified)

#### Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}$ =0V, $I_D$ =250uA	60	-		V
	Drain Source Leekage Current	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C			1	uA
IDSS	Drain-Source Leakage Current	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C			250	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm20V, V_{DS}=0V$			±100	nA

#### On Characteristics

D	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =9A		4.3	5.2	mΩ
$R_{DS(ON)}$		V <sub>GS</sub> =4.5V, I <sub>D</sub> =4A	-	6	7	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_{D}=250uA$	1.0	1.8	2.5	V
<b>g</b> fs	Forward Transconductance	$V_{DS}$ =5V, $I_{D}$ =4A	-	23		S

**Dynamic and switching Characteristics** 

$Q_{g}$	Total Gate Charge		 85	
$Q_gs$	Gate-Source Charge	$V_{DS}$ =30V, $V_{GS}$ =10V, $I_{D}$ =18A	 15	 nC
$Q_gd$	Gate-Drain Charge		 20	
$T_{d(on)}$	Turn-On Delay Time		 27	
T <sub>r</sub>	Turn-On Rise Time	$V_{DD}$ =30V, $V_{GS}$ =10V, $R_{G}$ =6 $\Omega$	 92	 ns
$T_{d(off)}$	Turn-Off Delay Time		 67	 115
$T_f$	Turn-Off Fall Time		 74	
$C_{iss}$	Input Capacitance		 4950	
$C_{oss}$	Output Capacitance	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz	 310	 pF
$C_{rss}$	Reverse Transfer Capacitance		 200	
$R_{g}$	Gate resistance	$V_{GS}$ =0V, $V_{DS}$ =0V, f=1MHz	 0.6	 Ω

#### **Drain-Source Diode Characteristics**

$V_{SD}^{3}$	Source to Drain Diode Voltage	$V_{GS}=0V$ , $I_{S}=18A$			1.5	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>s</sub> =18A, di/dt=100A/us	ł	22	1	ns
$Q_{rr}$	Reverse Recovery Charge	IS= IOA, UI/UI= IUUA/US		10		nC

#### Note:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. L=0.1mH,  $R_G=25\Omega$ , Starting  $T_J=25^{\circ}C$
- 3. The data tested by pulsed, pulse width  $\leq$ 300us, duty cycle  $\leq$ 2%.



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### 2. Characteristics Curves

### **Ratings and Characteristics Curves**

### (T<sub>A</sub> = 25°C unless otherwise specified)

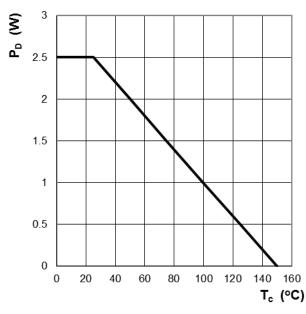


Figure 1: Power Dissipation

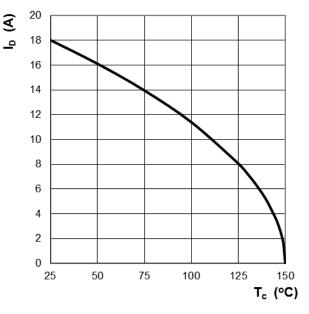


Figure 2: Continuous Drain Current vs. T<sub>C</sub>

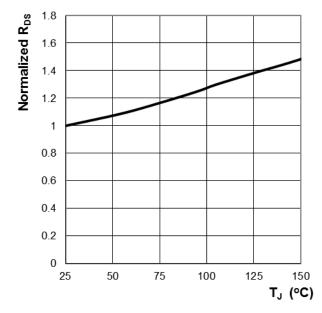


Figure 3: Normalized R<sub>DS(ON)</sub> vs. T<sub>J</sub>

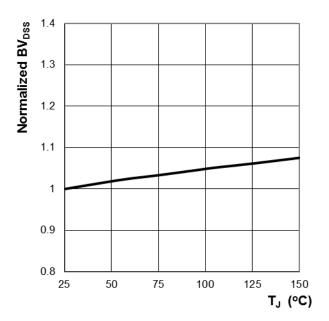


Figure 4: Normalized BV<sub>DSS</sub> vs. T<sub>J</sub>



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#### **Ratings and Characteristics Curves**

### ( $T_A = 25^{\circ}$ C unless otherwise specified)

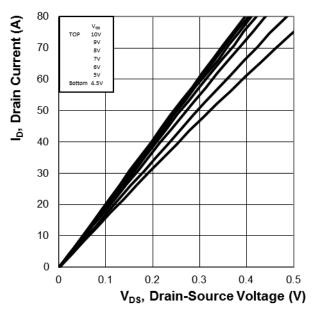


Figure 5: On-Region Characteristics

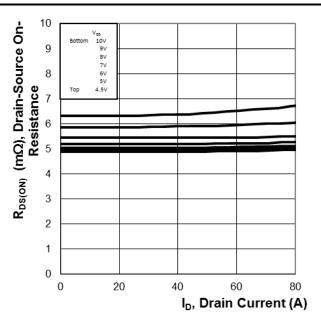


Figure 6: Typ.  $R_{DS}$  Variation vs.  $I_D$  and  $V_{GS}$ 

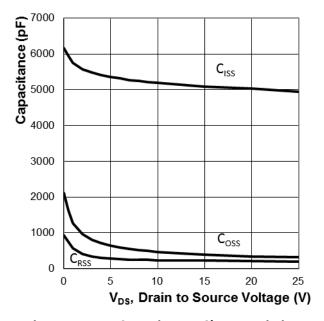
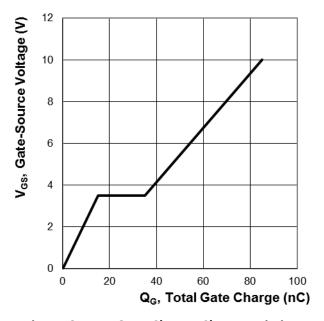


Figure 7: Typ. Capacitance Characteristics



**Figure 8: Typ. Gate Charge Characteristics** 



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### **Ratings and Characteristics Curves**

# (T<sub>A</sub> = 25°C unless otherwise specified)

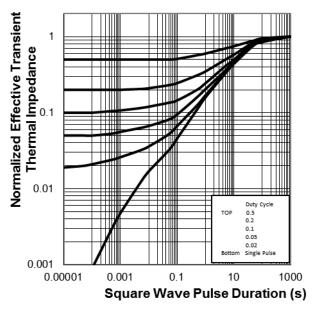


Figure 9: Normalized Thermal Transient Impedance, Junction-to-Case

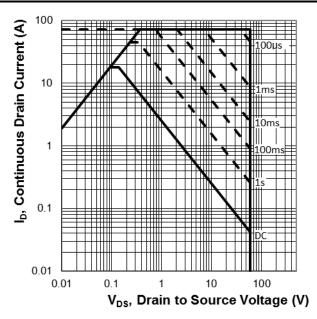


Figure 10: Maximum Safe Operation Area



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# 3. Marking information

**Top Marking Rule** 

PFC PRM
5R2N06S8
YYWW ABSH

PRM5R2N06S8 = Product Type Marking Code

YYWW = Date Code

YY = Last two digits of year

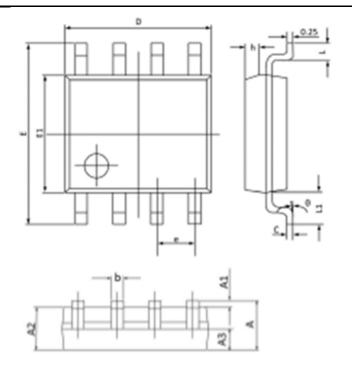
WW = Week code

ABS = Assembly code

H = Halogen Free (N/A = common molding compound)

## 4. Package information

### Package Outline Dimensions millimeters



Dim.	Min.	Max.			
A	1.35	1.75			
Al	0.10	0.25			
A2	1.30				
A3	0.60	0.70			
b	0.35	0.49			
С	0.18	0.26			
D	4.70 5.10				
E	5.80	6.20			
E1	3.70	4.10			
e	1.27	BSC			
h	0.25	0.50			
L	0.40	0.90			
Ll	1.05 BSC				
θ	0°	8°			
All Dimensions in mm					



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### 5. Ordering information

Part Number	Package	Delivery mode
PRM5R2N06S8	SOP-8	3000 pcs / 13" diameter reel

#### Mechanical

Molder Plastic: UL Flammability Classification Rating 94V-0
 Device Weight: 0.003 ounces (0.085grams) – SOP-8

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